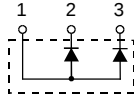
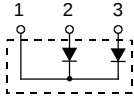
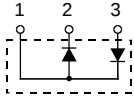


Fast Recovery Epitaxial Diode (FRED) Module

MEA 95-06 DA
MEK 95-06 DA
MEE 95-06 DA

$V_{RRM} = 600 \text{ V}$
 $I_{FAV} = 95 \text{ A}$
 $t_{rr} = 250 \text{ ns}$

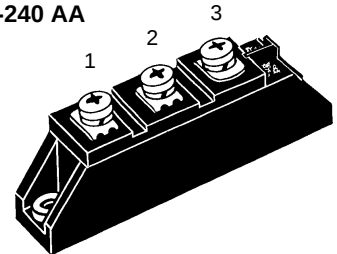
V_{RSM} V	V_{RRM} V	Type
600	600	MEA95-06 DA  MEK 95-06 DA  MEE 95-06 DA 

Symbol	Test Conditions	Maximum Ratings	
I_{FRMS}	$T_{case} = 75^{\circ}\text{C}$	142	A
$I_{FAV}^{①}$	$T_{case} = 75^{\circ}\text{C}$; rectangular, $d = 0.5$	95	A
I_{FRM}	$t_p < 10 \mu\text{s}$; rep. rating, pulse width limited by T_{VJM}	TBD	A
I_{FSM}	$T_{VJ} = 45^{\circ}\text{C}$; $t = 10 \text{ ms}$ (50 Hz), sine	1200	A
	$t = 8.3 \text{ ms}$ (60 Hz), sine	1300	A
	$T_{VJ} = 150^{\circ}\text{C}$; $t = 10 \text{ ms}$ (50 Hz), sine	1080	A
	$t = 8.3 \text{ ms}$ (60 Hz), sine	1170	A
I^2t	$T_{VJ} = 45^{\circ}\text{C}$; $t = 10 \text{ ms}$ (50 Hz), sine	7200	A^2s
	$t = 8.3 \text{ ms}$ (60 Hz), sine	7100	A^2s
	$T_{VJ} = 150^{\circ}\text{C}$; $t = 10 \text{ ms}$ (50 Hz), sine	5800	A^2s
	$t = 8.3 \text{ ms}$ (60 Hz), sine	5700	A^2s
T_{VJ}		-40...+150	$^{\circ}\text{C}$
T_{stg}		-40...+125	$^{\circ}\text{C}$
T_{Hmax}		110	$^{\circ}\text{C}$
P_{tot}	$T_{case} = 25^{\circ}\text{C}$	280	W
V_{ISOL}	50/60 Hz, RMS $t = 1 \text{ min}$	3000	V~
	$I_{ISOL} \leq 1 \text{ mA}$ $t = 1 \text{ s}$	3600	V~
M_d	Mounting torque (M5)	2.5-4/22-35	Nm/lb.in.
	Terminal connection torque (M5)	2.5-4/22-35	Nm/lb.in.
d_s	Creep distance on surface	12.7	mm
d_A	Strike distance through air	9.6	mm
a	Maximum allowable acceleration	50	m/s^2
Weight		90	g

Symbol	Test Conditions	Characteristic Values (per diode)	
		typ.	max.
I_R	$T_{VJ} = 25^{\circ}\text{C}$ $V_R = V_{RRM}$		2 mA
	$T_{VJ} = 25^{\circ}\text{C}$ $V_R = 0.8 \cdot V_{RRM}$		0.5 mA
	$T_{VJ} = 125^{\circ}\text{C}$ $V_R = 0.8 \cdot V_{RRM}$		34 mA
V_F	$I_F = 100 \text{ A}$; $T_{VJ} = 125^{\circ}\text{C}$		1.36 V
	$T_{VJ} = 25^{\circ}\text{C}$		1.55 V
	$I_F = 300 \text{ A}$; $T_{VJ} = 125^{\circ}\text{C}$		2.05 V
	$T_{VJ} = 25^{\circ}\text{C}$		2.09 V
V_{T0}	For power-loss calculations only	1.01	V
r_T	$T_{VJ} = 125^{\circ}\text{C}$	2.85	$\text{m}\Omega$
R_{thJH}	DC current	0.550	K/W
R_{thJC}	DC current	0.450	K/W
t_{rr} I_{RM}	$I_F = 100 \text{ A}$ $T_{VJ} = 100^{\circ}\text{C}$	250	300 ns
	$V_R = 300 \text{ V}$ $T_{VJ} = 25^{\circ}\text{C}$		14 A
	$-di/dt = 200 \text{ A}/\mu\text{s}$ $T_{VJ} = 100^{\circ}\text{C}$		21 A

① I_{FAV} rating includes reverse blocking losses at T_{VJM} , $V_R = 0.6 V_{RRM}$, duty cycle $d = 0.5$
Data according to IEC 60747
IXYS reserves the right to change limits, test conditions and dimensions

TO-240 AA



Features

- International standard package with DCB ceramic base plate
- Planar passivated chips
- Short recovery time
- Low switching losses
- Soft recovery behaviour
- Isolation voltage 3600 V~
- UL registered E 72873

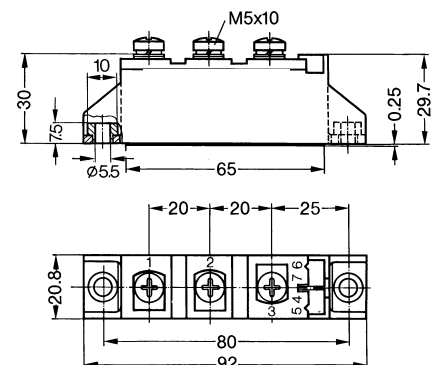
Applications

- Antiparallel diode for high frequency switching devices
- Free wheeling diode in converters and motor control circuits
- Inductive heating and melting
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders

Advantages

- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching
- Low losses

Dimensions in mm (1 mm = 0.0394")



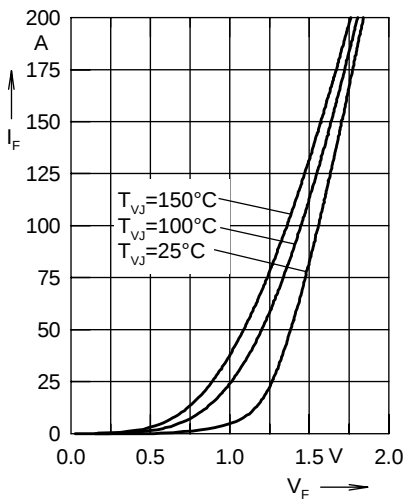


Fig. 1 Forward current I_F versus voltage drop V_F per leg

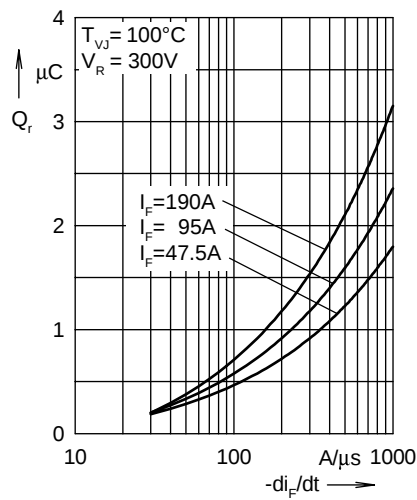


Fig. 2 Reverse recovery charge Q_r versus $-di_F/dt$

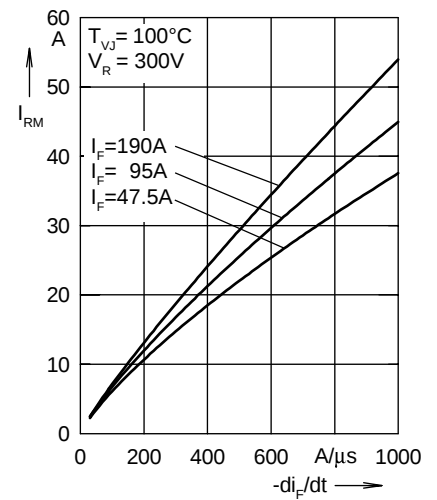


Fig. 3 Peak reverse current I_{RM} versus $-di_F/dt$

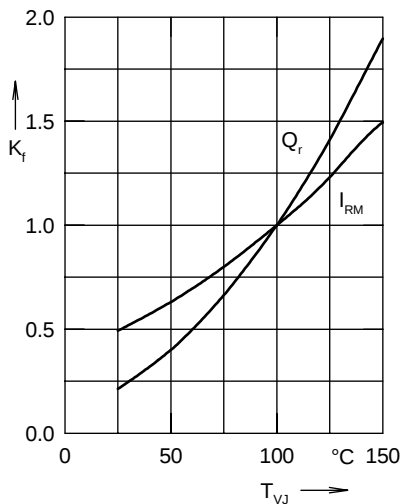


Fig. 4 Dynamic parameters Q_r , I_{RM} versus junction temperature T_{VJ}

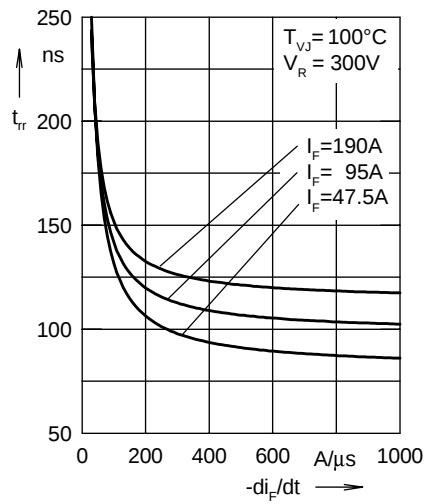


Fig. 5 Recovery time t_{rr} versus $-di_F/dt$

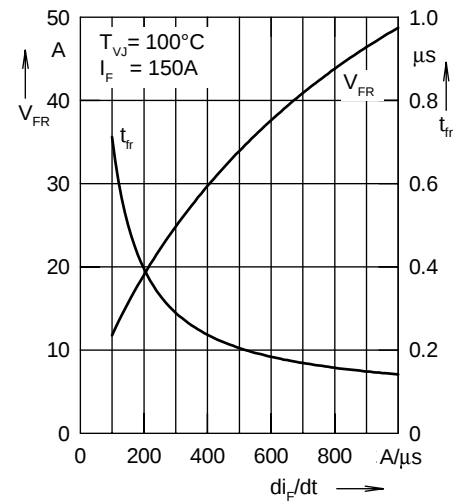


Fig. 6 Peak forward voltage V_{FR} and t_{rr} versus di_F/dt

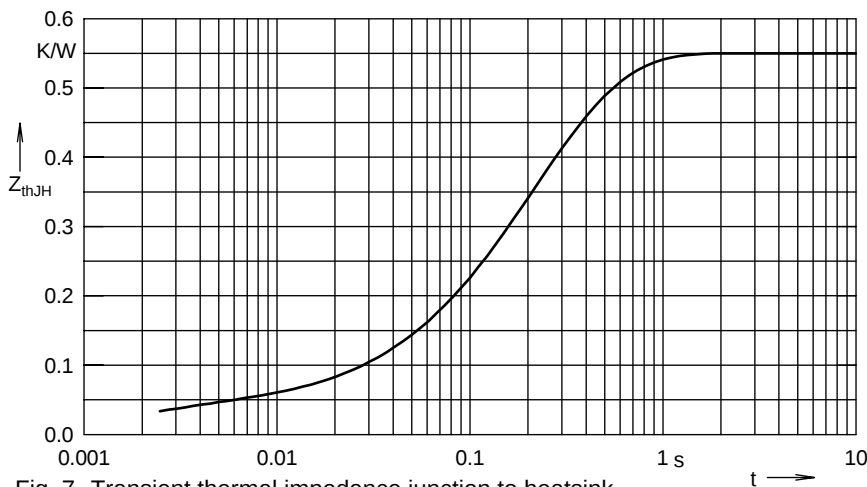


Fig. 7 Transient thermal impedance junction to heatsink

Constants for Z_{thJH} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.037	0.002
2	0.138	0.134
3	0.093	0.25
4	0.282	0.274